Key Features :

- Frequency range : 7 13GHz
- Typical gain : 26dB @ 28mA 23dB @ 13mA
- Input/Output standing wave : 2/1.3
- Noise figure : 0.8dB
- P-1 : 9dBm @ +5V/28mA
 3dBm @ +5V/13mA (Low power mode)
- Chip dimensions : 1.3mm x 0.95mm x 0.1mm
- Applications : wireless communication, transceiver module, radio telecommunication etc.

Description:

AMT1230 chip is a Gallium Arsenide (GaAs) high performance Low Noise Amplifier, it covers 7 – 13GHz frequency range. It uses +5V single voltage operation, noise figure is 0.8dB, and 26dB typical gain. This chip is designed with ground through metal vias on the back technology.

Absolute Maximum Ratings (Ta = 25°C)

Symbol	Parameter	Value	Remark		
Vd	Drain Voltage	+7V			
Pin	Input Signal Power	17dBm			
Tch	Operating Temperature	150°C			
Tm	Sintering Temperature	310°C	30s, N ₂ protection		
Tstg	Storage Temperature	-65 ~ +150°C			

[1] Operation outside any of the Absolute Maximum Ratings may cause permanent device damage.

Electrical Characteristics (Ta = 25°C)

Symbol	Parameter	Test Conditions	Value		Unit	
			Min	Typical	Max	
G	Gain		-	26	-	dB
NF	Noise Figure		-	0.8	-	dB
Id	Static Current	Vd = +5V	-	28	-	mA
VSWR_in	Input Standing Wave	F : 7 ~ 13GHz	-	2.1	-	-
VSWR_out	Output Standing Wave		-	1.3	-	-
P-1	Output Power at 1dB point		-	9	-	dBm





Typical Performance



Gain Curve



P-1 Compression Characteristic Curve



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Freq, GHz

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12

13

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AMT1230 7 – 13GHz Low Noise Amplifier Chip



Typical Performance (Low Power Mode)

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Chip Dimensions (Unit : µm)



Chip Layout Diagram



Normal Mode



Low Power Mode (G1 connected to G)

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Pad Definition

Symbol	Function Description	Demensions
RFin	RF signal input port, connecting to external 50 Ω system, no need to add DC	100µm*100µm
	blocking capacitor.	
RFout	RF signal output port, connecting to external 50 Ω system, no need to add	100µm*100µm
	DC blocking capacitor.	
Vd	Amplifier bias, need to connect 100pF external capacitor	100µm*100µm
G1	Low power mode when connected to G pad	100µm*80µm
G	Ground	100µm*100µm

Please see Appendix A for details.

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